FROM RESEARCH TO INDUSTRY







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CEA COUPLER ACTIVITY UPDATE

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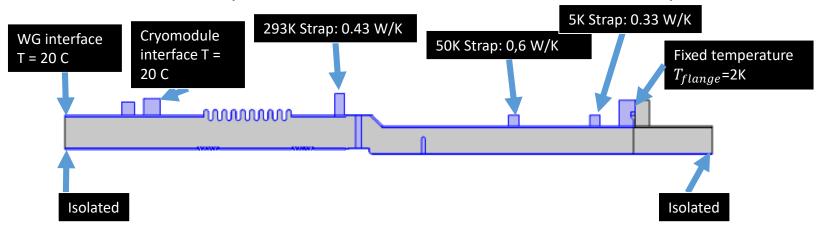
PIP-II Coupler collaboration meeting

Comsol 2D thermal calculation model

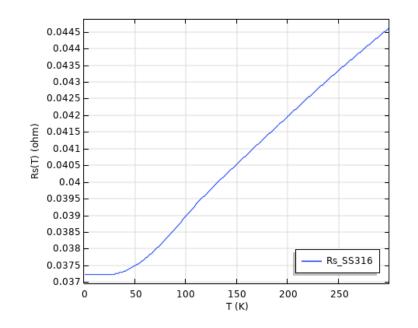


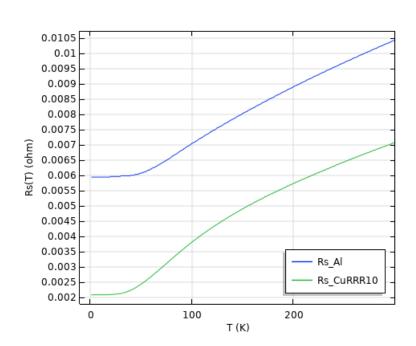
☐ We added the Al gasket in this model in order to perform the RF calculation not shown in this presentation

Old straps configuration



Surface resistance of material used on coupler to cavity interface

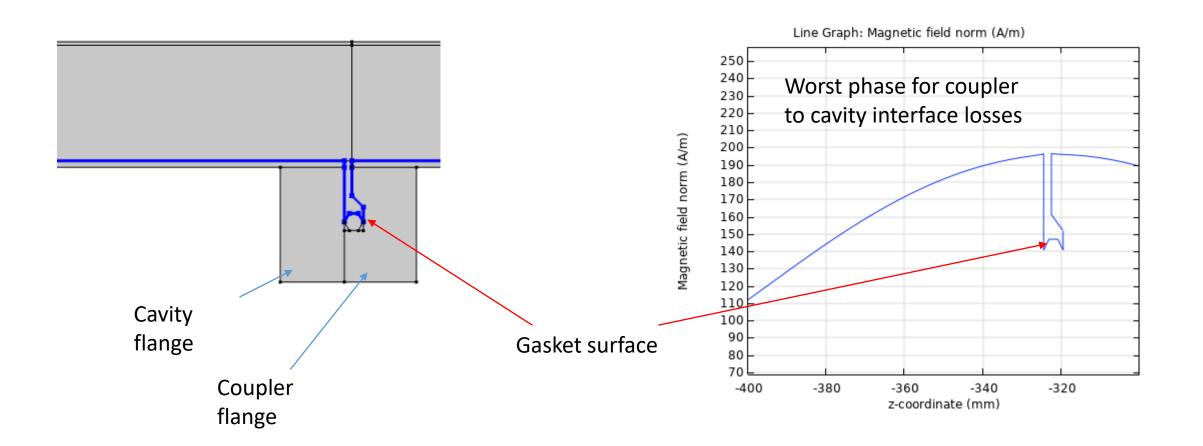




Magnetic field on coupler to cavity interface flanges

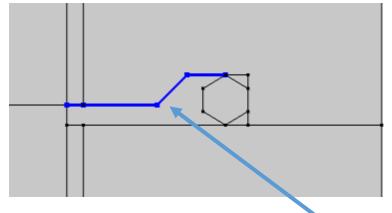


Fwd power= 50 kW CW
Ref. power = 10 kW CW(all phase)

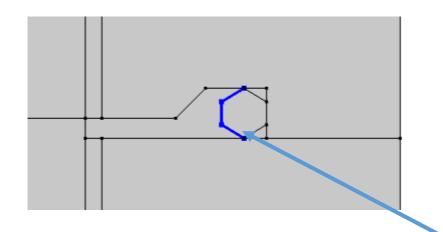


Flange interface RF losses





SS surface Flange RF losses

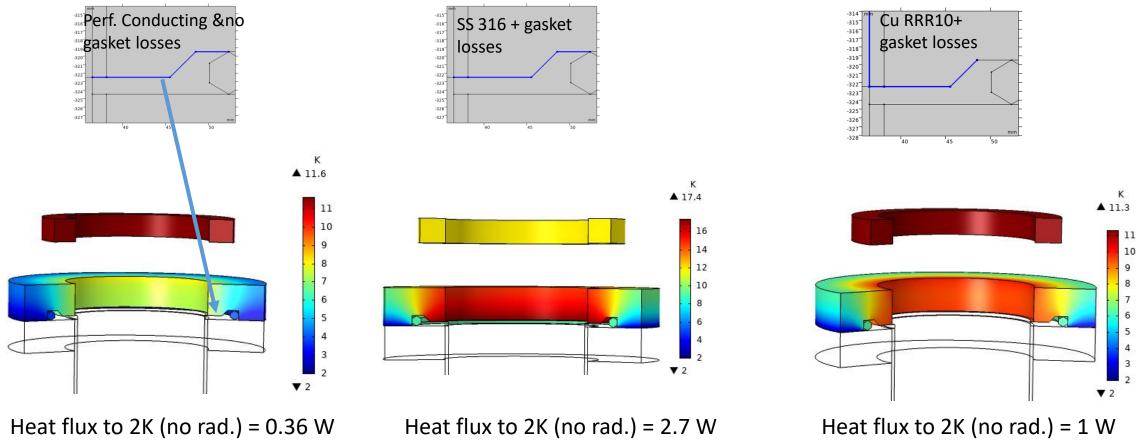


RF power losses [W] 2.5 **Paner Losses [W]**2 1.5 1
0.5 0 6 **Reflection phases [rad]**

Al Gasket RF losses

Effect of the flange surface and the gasket





- ☐ The copper plating of the coupler to cavity surface seems to be mandatory to reduce the conductive heat flux to cavity. It needs to be requested and controlled during manufacturing.
- ☐ The results will be updated using the new straps configuration



We received the Fermilab 3D model for RF and thermal calculations.
 It will be used for the next studies